



EUROPEAN POWER SUPPLY MANUFACTURERS ASSOCIATION  
(Visit the EPSMA website at [www.epsma.org](http://www.epsma.org))

## Medical Approvals for Power Supplies

### Guidelines to the standard IEC60601

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This document gives an overview of design issues, definitions and useable standards currently used in AC/DC power supplies for medical applications. It aims to provide a common understanding of which safety rules and certifications should be used depending on the final application of the standard.

Furthermore this document provides a general interpretation of how different standards - requirements are in practice realized in power supplies.

This paper does NOT intend to be a standard

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Contents:

- Medical Approvals for Power Supplies ..... 1**
- 1. Introduction ..... 3**
- 2. Summary ..... 4**
- 3. Determination of Creepage and Clearance distances..... 5**
  - 3.1 Classification in “Equipment Parts” ..... 5
  - 3.2 Calculation of the required Insulation (Isolation diagram) ..... 5
  - 3.3 Calculation of the working voltage “reference voltage” ..... 6
  - 3.4 Determination of Creepage and Clearance Distances ..... 6
- 4. Construction Requirements..... 7**
  - 4.1 Insulation Diagram..... 7
  - 4.2 Creepage and Clearance:..... 8
  - 4.3 Leakage current requirement ..... 9
  - 4.4 Requirements for input stage ..... 12
  - 4.5 Temperature measurement and requirements ..... 12
  - 4.6 Requirements for the multilayer PCB board..... 12
  - 4.7 Dielectric Testing..... 12
  - 4.8 Maximum output Energy ..... 13
  - 4.9 Enclosure and mechanical requirements ..... 13
- 5. Risk Analysis..... 13**
- 6. Conditions of Acceptability ..... 13**